TEL: 1-281-870-8822 EMAIL:Sales@DynamicEng.com



Features and Benefits

9.5MHz—60MHz Frequency range 1.8V,2.5V, and 3.3V Supply voltage CMOS Output waveform ±2.5ppm Stability Vs -40C --+85C 3.2x2.5mm Size

Typical Applications

Wireless Connectivity Smart grid

Mechanical Drawing & Pin Connections

Top View

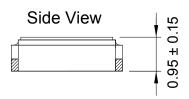
3.20 ± 0.15

#4

#3

#1

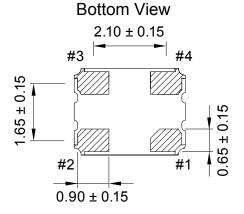
#2

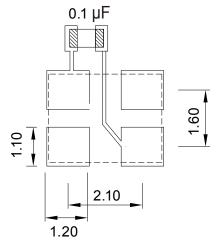


Pin#	Function
1	Tri-state
2	GND
3	Output
4	VDD

Unit in mm 1mm = 0.0394 inches Drawing No: MI

MD160027-4





To ensure optimal oscillator performance, place a by-pass capacitor of $0.1\mu F$ as close to the part as possible between Vdd and GND pads.



Dynamic Engineers Inc.

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TCXO3226S_series
3.2 X 2.5 mm SMD CMOS TCXO

Specifications

Specification	Conditon	3.3V		2.5V		1.8V		Heit
Specification		Min.	Max.	Min.	Max.	Min.	Max.	Unit
Supply Voltage Variation(VDD)	±5%	3.135	3.465	2.375	2.625	1.71	1.89	V
Frequency Range		9.5	60	9.5	60	9.5	60	MHz
Aging(first year)	@25°C		±1.0		±1.0		±1.0	ppm
Supply Current	9.5MHz≪Fo≪60MHz	-	10	-	7	-	5	mA
Output Level(CMOS)	High (logic 1)	2.97	-	2.25	-	1.62	-	V
	Low (logic 0)		0.33		0.25		0.18	V
Duty Cycle		45	55	45	55	45	55	%
Rise/Fall time			8		8		8	nSec
Start Time			5		5		5	mSec
Tri-state(input to pin1)	Enable(high or floating)	2.31		1.75		1.26		V
	Disable(low or GND)		0.99		0.75		0.54	V
RMS Phase Jitter	Integrated 12kHz-20MHz		1		1		1	pSec
Phase Noise@26MHz								
10Hz			-80		-80		-80	
100Hz			-110		-110		-110	dBc/H
1KHz			-130		-130		-130	Z Z
10KHz			-145		-145		-145	
Storage Temp. Range		-55°C to +125°C				°C		

Frequency Stability vs. Temperature

	±2.5PPM	±5.0PPM	±10PPM
-40°C to +85°C	Available	Available	Available
-40°C to +90°C	Conditional	Available	Available
-40°C to +105°C	Not Available	Conditional	Available

Note: not all combination of options are available. Other specifications may be available upon request.